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PATENT Docket No. 1948-4631

AF

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) ...:

NICOLAI et al.

Group Art Unit: 3729

Serial No.

09/423,075

Examiner: S. Smith

Filed

November 1, 1999

For

SHIELDING AN ELECTRONIC CARD WITH PRINTED CIRCUIT

MOUNTED ON A METAL SUBSTRATE

CERTIFICATE OF MAILING (37 C.F.R. 1.8a)

Commissioner for Patents Washington, D.C. 20231

RECEIVED

AUG 1 9 2002

Sir:

TECHNOLOGY CENTER R3700

I hereby certify that the following attached papers

- 1. Amendment under 37 C.F.R. § 1.116; and
- 2. Return postcard.

(along with any papers referred to as being attached or enclosed) and this Certificate of Mailing are being deposited with the United States Postal Service on the date shown below with sufficient postage as first-class mail in an envelope addressed to the: Commissioner for Patents, Washington, D.C. 20231.

Respectfully submitted,

MORGAN & FINNEGAN

Date: August 8, 2002

Richard D. Ratchford J

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SHIELDING AN ELECTRONIC CARD WITH PRINTED CIRCUIT MOUNTED

Group Art Unit:

ON A METAL SUBSTRATE

AMENDMENT UNDER 37 C.F.R. § 1.116

Commissioner for Patents Washington, DC 20231 Box AF

Sir:

This Amendment Under 37 C.F.R. § 1.116 is submitted in response to the Final

Rejection dated May 8, 2002. Applicants respectfully request consideration of the above-identified application in view of the following amendments and remarks.

Please amend this application as follows. An appendix hereto shows the claim amendments with interlineations and deletions.

IN THE CLAIMS

Please AMEND claim 4 as follows:

(Amended) A method of producing an assembly comprising a printed-circuit

electronics card mounted on a metal substrate with a metal screening cover electrically connected to the substrate, the method comprising:

forming a gutter on a metallic substrate by stamping;

Part to be